



0.3A SBR SUPER BARRIER RECTIFIER

Features

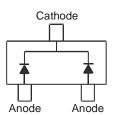
- Low Forward Voltage
- Ultra Low Reverse Leakage
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Patented Super Barrier Rectifier SBR[®] Technology
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208(2)
- Terminal Connections: See Diagram
- Weight: 0.008 grams (Approximate)







Equivalent Circuit

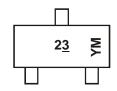
Ordering Information (Note 4)

Part Number	Case	Packaging
SBR0330CW-7	SOT323	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



23 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: C = 2015) M = Month (ex: 9 = September)

Date Code Key

Year	2015	2016	2017	201	8 2	2019	2020	2021	202	2 2	2023	2024
Code	С	D	Е	F		G	Н	ı	J		K	L
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	30	V
DC Forward Current	I _F (Per diode)	0.3	Δ
Average Rectified Output Current	lo	0.5	
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	1	А

Thermal Characteristics

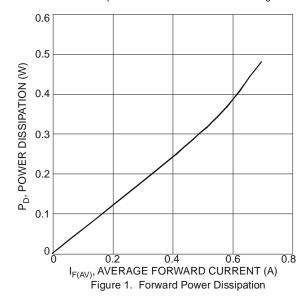
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Thermal Resistance Junction to Ambient (Note 5)	$R_{ heta JA}$	261	°C/W
Typical Thermal Resistance Thermal Resistance Junction to Ambient (Note 6)	$R_{\theta JA}$	445	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

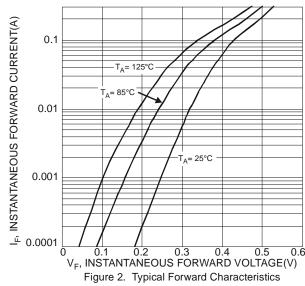
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
				240		$I_F = 0.1 \text{mA}, T_J = +25 ^{\circ}\text{C}$
Forward Voltage Drop	V _F	_	_	300		$I_F = 1 \text{mA}, T_J = +25 ^{\circ}\text{C}$
				375	mV	$I_F = 10 \text{mA}, T_J = +25 ^{\circ}\text{C}$
				430		$I_F = 30 \text{mA}, T_J = +25 ^{\circ}\text{C}$
				500		$I_F = 100 \text{mA}, T_J = +25 ^{\circ}\text{C}$
				580		$I_F = 200 \text{mA}, T_J = +25 ^{\circ}\text{C}$
		1	530			$I_F = 300 \text{mA}, T_J = +25 ^{\circ}\text{C}$
	I _R			5	μΑ	$V_R = 30V, T_J = +25^{\circ}C$
		1	0.63	3		$V_R = 25V, T_J = +25^{\circ}C$
Leakage Current (Note 7)				1		$V_R = 10V, T_J = +25^{\circ}C$
		_	0.35	0.8		$V_R = 5V, T_J = +25^{\circ}C$
		_	7	20		$V_R = 10V, T_J = +70^{\circ}C$
		_	18	50		$V_R = 10V, T_J = +85^{\circ}C$

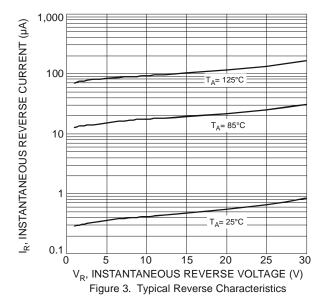
Notes:

- Device mounted on Polymide substrate, 10cm x 10cm, 2oz, copper, PC boards.
 Device mounted on FR-4 PCB, 2oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.
- 7. Short duration pulse test used to minimize self-heating effect.









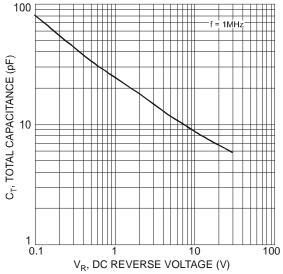


Figure 4. Total Capacitance vs. Reverse Voltage

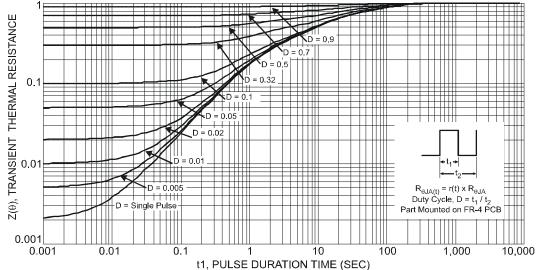
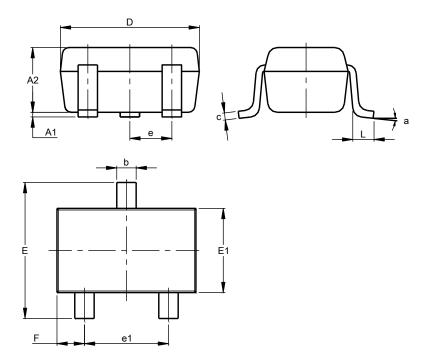


Figure 5. Transient Thermal Resistance



Package Outline Dimensions

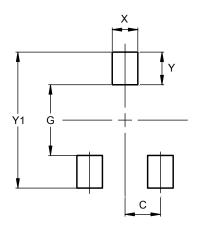
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT323						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.25	0.40	0.30			
С	0.10	0.18	0.11			
D	1.80	2.20	2.15			
E	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	0.650 BSC					
e1	1.20	1.40	1.30			
F	0.375	0.475	0.425			
L	0.25	0.40	0.30			
а	8°					
All Dimensions in mm						

Suggested Pad Layout

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



Dimensions	Value (in mm)
C	0.650
G	1.300
Х	0.470
Υ	0.600
Y1	2.500



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